## MICRON.170A

. ~

ç

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Applicant** 

Paul A. Farrar

Appl. No.

09/909,181

Filed

July 19, 2001

For

A METHOD OF USING FOAM

INSULATORS IN MULTICHIP

CUBE STRUCTURES

Examiner

Chris C. Chu

Group Art Unit 2815

FAX RECEIVED

JUL 0 2 2003

TECHNOLOGY CENT

## AMENDMENT AFTER FINAL

United States Patent and Trademark Office P.O. Box 2327 Arlington, VA 22202 ATTENTION BOX: AF

## Dear Sir:

In response to the Office Action mailed January 13, 2003, please amend the above captioned application as follows.